BLP9H10S-500AWT

Power LDMOS transistor

Rev. 2 — 18 December 2020

1. Product profile

1.1 General description

500 W LDMOS packaged asymmetric Doherty power transistor for base station applications at frequencies from 600 MHz to 960 MHz.

Table 1. Typical performance

Typical RF performance at $T_{case} = 25 \,^{\circ}$ C in an asymmetrical Doherty circuit; $V_{DS} = 48 \,$ V; $I_{Dq} = 200 \,$ mA (main); $V_{GS(amp)peak} = 0.3 \,$ V, unless otherwise specified.

| Test signal | f | V _{DS} | P _{L(AV)} | G _p | ησ | ACPR |
|------------------|------------|-----------------|--------------------|----------------|------|------------------------|
| | (MHz) | (V) | (dBm) | (dB) | (%) | (dBc) |
| 1-carrier W-CDMA | 758 to 821 | 48 | 50.1 | 17.6 | 52.4 | –29.8 <mark>[1]</mark> |

[1] Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 9.9 dB at 0.01 % probability on CCDF.

1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent digital pre-distortion capability
- Internal integrated wideband input and output matching for ease of use
- Integrated double sided ESD protection
- Bias through video leads
- For RoHS compliance see the product details on the Ampleon website

1.3 Applications

 RF power amplifiers for base stations and multi carrier applications in the 600 MHz to 960 MHz frequency range

2. Pinning information

| Table 2. Pir | nning | | |
|--------------|-----------------|--------------------|------------------------|
| Pin | Description | Simplified outline | Graphic symbol |
| 1, 2 | gate | | |
| 3, 6 | decoupling lead | | 4 3 |
| 4, 5 | drain | | |
| 7 | source [1] | | |
| | | 1 2 | • + 6 5 amp01359 |

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

| Type number | Package | | | | |
|-----------------|---------|--|--------------|--|--|
| | Name | Description | Version | | |
| BLP9H10S-500AWT | - | overmolded plastic earless flanged package; 6 leads | OMP-780-6F-1 | | |

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|--------------------------|------------------------------------|---------------|-----|------|------|
| V _{DS} | drain-source voltage | | - | 105 | V |
| V _{GS(amp)main} | main amplifier gate-source voltage | | -6 | +11 | V |
| V _{GS(amp)peak} | peak amplifier gate-source voltage | | -6 | +11 | V |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | <u>[1]</u> | - | 225 | °C |
| T _{case} | case temperature | operating [1] | -40 | +125 | °C |

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

5. Thermal characteristics

Table 5.Thermal characteristics

| Symbol | Parameter | Conditions | Тур | Unit |
|----------------------|--|--|------|------|
| R _{th(j-c)} | thermal resistance from junction to case | $\label{eq:VDS} \begin{array}{l} V_{DS} = 48 \ V; \ I_{Dq} = 500 \ mA \ (main); \\ V_{GS(amp)peak} = 0.3 \ V; \ T_{case} = 80 \ ^{\circ}C \end{array}$ | | |
| | | P _L = 76 W | 0.55 | K/W |
| | | P _L = 85 W | 0.51 | K/W |

6. Characteristics

Table 6.DC characteristics

 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------|----------------------------------|--|------|------|------|------|
| Main dev | rice | 1 | | | | |
| V _{(BR)DSS} | drain-source breakdown voltage | $V_{GS} = 0 \text{ V}; I_D = 1.5 \text{ mA}$ | 108 | - | - | V |
| V _{GS(th)} | gate-source threshold voltage | V _{DS} = 10 V; I _D = 150 mA | 1.5 | 2.0 | 2.5 | V |
| V _{GSq} | gate-source quiescent voltage | V _{DS} = 48 V; I _D = 500 mA | 1.55 | 2.07 | 2.55 | V |
| I _{DSS} | drain leakage current | $V_{GS} = 0 V; V_{DS} = 50 V$ | - | - | 1.4 | μA |
| I _{DSX} | drain cut-off current | $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$ | - | 23.8 | - | A |
| I _{GSS} | gate leakage current | $V_{GS} = 11 \text{ V}; V_{DS} = 0 \text{ V}$ | - | - | 140 | nA |
| g _{fs} | forward transconductance | V _{DS} = 10 V; I _D = 7.5 A | - | 10.2 | - | S |
| R _{DS(on)} | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75 V;$ I _D = 5.25 A | - | 154 | 250 | mΩ |
| Peak dev | vice | 1 | 1 | | | 1 |
| V _{(BR)DSS} | drain-source breakdown voltage | $V_{GS} = 0 \text{ V}; \text{ I}_{D} = 2.2 \text{ mA}$ | 108 | - | - | V |
| V _{GS(th)} | gate-source threshold voltage | V _{DS} = 10 V; I _D = 220 mA | 1.5 | 1.9 | 2.5 | V |
| V _{GSq} | gate-source quiescent voltage | V _{DS} = 48 V; I _D = 1100 mA | 1.5 | 1.99 | 2.5 | V |
| I _{DSS} | drain leakage current | $V_{GS} = 0 V; V_{DS} = 50 V$ | - | - | 1.4 | μA |
| I _{DSX} | drain cut-off current | $V_{GS} = V_{GS(th)} + 3.75 V;$ $V_{DS} = 10 V$ | - | 34.5 | - | A |
| I _{GSS} | gate leakage current | $V_{GS} = 11 \text{ V}; V_{DS} = 0 \text{ V}$ | - | - | 140 | nA |
| 9 _{fs} | forward transconductance | V _{DS} = 10 V; I _D = 11 A | - | 15.0 | - | S |
| R _{DS(on)} | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75 V;$ I _D = 7.7 A | - | 109 | 174 | mΩ |

Table 7. RF characteristics

A derivative functional RF test is performed in production. The performance as mentioned below is based on an asymmetrical Doherty application board and correlated to the production circuit. Test signal: 1-carrier W-CDMA; PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 - 64 DPCH; $f_1 = 793.5$ MHz; $f_2 = 818.5$ MHz; RF performance at $V_{DS} = 48$ V; $I_{Dq} = 500$ mA (main); $V_{GS(amp)peak} = 0.3$ V; $T_{case} = 25$ °C; unless otherwise specified; in an

asymmetrical Doherty test circuit at frequencies from 791 MHz to 821 MHz.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|------------------------------|---------------------------|------|-------|-----|------|
| G _p | power gain | P _{L(AV)} = 76 W | 17.5 | 18.3 | - | dB |
| RL _{in} | input return loss | P _{L(AV)} = 76 W | - | -12.7 | -9 | dB |
| η _D | drain efficiency | P _{L(AV)} = 76 W | 47 | 51 | - | % |
| ACPR | adjacent channel power ratio | P _{L(AV)} = 76 W | - | -34.8 | -32 | dBc |

550

620

Unit dB

W

Table 8. RF characteristics

A derivative functional RF test is performed in production. The performance as mentioned below is based on an asymmetrical Doherty application board and correlated to the production circuit. Test signal: 1-carrier W-CDMA; PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 - 64 DPCH; $f_1 = 793.5$ MHz; $f_2 = 818.5$ MHz; RF performance at $V_{DS} = 48$ V; $I_{Dq} = 500$ mA (main); $V_{GS(amp)peak} = 0.3$ V; $T_{case} = 25$ °C; unless otherwise specified; in an

 $P_{L(AV)} = 135 \text{ W}$

| asymmetric | a Doneny lest circuit at frequencies | | IVINZ. | | |
|------------|--------------------------------------|----------------------------|--------|-----|-----|
| Symbol | Parameter | Conditions | Min | Тур | Max |
| PARO | output peak-to-average ratio | P _{L(AV)} = 135 W | 6.2 | 6.7 | - |

7. Test information

P_{L(M)}

7.1 Ruggedness in Doherty operation

peak output power

The BLP9H10S-500AWT is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: $V_{DS} = 50$ V; $I_{Dq} = 500$ mA; $V_{GS(amp)peak} = 0.3$ V; f = 791 MHz; $P_L = 200$ W (5 dB OBO); 1-carrier W-CDMA signal; $f_c = 791$ MHz; 100 % clipping.

7.2 Impedance information

Table 9. Typical impedance of main device

Measured load-pull data of main device; $I_{Dq} = 600 \text{ mA}$ (main); $V_{DS} = 48 \text{ V}$; pulsed CW ($t_p = 100 \mu s$; $\delta = 10 \%$).

| f | Z _S [1] | Z _L [1] | P _L [2] | η <mark>ρ ^[2]</mark> | G _p [2] | | | | | |
|---------|---------------------|---------------------|--------------------|---------------------------------|--------------------|--|--|--|--|--|
| (MHz) | (Ω) | (Ω) | (W) | (%) | (dB) | | | | | |
| Maximum | laximum power load | | | | | | | | | |
| 600 | 5.3 – j1.02 | 4.0 – j3.1 | 325.5 | 65.7 | 18.0 | | | | | |
| 617 | 4.9 – j0.7 | 4.0 – j3.1 | 322.3 | 65.1 | 18.3 | | | | | |
| 635 | 4.4 – j0.69 | 4.0 – j3.1 | 299.8 | 61.0 | 18.3 | | | | | |
| 652 | 4.1 – j0.69 | 3.0 – j2.4 | 260.2 | 52.9 | 17.6 | | | | | |
| 698 | 3.5 – j1.25 | 3.0 – j2.4 | 321.7 | 65.1 | 18.7 | | | | | |
| 746 | 3.3 – j1.92 | 3.0 – j2.4 | 316.8 | 66.0 | 18.7 | | | | | |
| 769 | 3.3 – j2.26 | 3.0 – j2.4 | 312.4 | 66.9 | 18.8 | | | | | |
| 805 | 3.4 – j2.77 | 3.0 – j2.4 | 295.2 | 66.7 | 19.0 | | | | | |
| 820 | 3.5 – j3.02 | 3.0 – j2.4 | 295.5 | 67.9 | 19.0 | | | | | |
| 869 | 4.1 – j3.74 | 2.9 – j3.8 | 293.2 | 59.5 | 17.9 | | | | | |
| 880 | 4.3 – j3.85 | 2.9 – j3.8 | 292.0 | 60.7 | 18.0 | | | | | |
| 894 | 4.6 – j4.03 | 2.9 – j3.8 | 288.0 | 60.5 | 18.0 | | | | | |
| 915 | 5.0 – j4.22 | 2.8 – j3.8 | 284.9 | 61.7 | 18.1 | | | | | |
| 925 | 5.3 – j4.27 | 2.9 – j3.8 | 281.2 | 63.1 | 18.2 | | | | | |
| 942 | 5.8 – j4.32 | 3.6 – j4.9 | 277.9 | 59.7 | 17.8 | | | | | |
| 960 | 6.4 – j4.28 | 3.7 – j4.9 | 273.1 | 59.9 | 18.0 | | | | | |

Table 9. Typical impedance of main device ...continued

Measured load-pull data of main device; $I_{Dq} = 600 \text{ mA}$ (main); $V_{DS} = 48 \text{ V}$; pulsed CW ($t_p = 100 \mu$ s; $\delta = 10 \%$).

| f | Z _S [1] | Z _L [1] | P _L [2] | η <mark>ρ [2]</mark> | G p [2] |
|---------|----------------------|--------------------|--------------------|----------------------|----------------|
| (MHz) | (Ω) | (Ω) | (W) | (%) | (dB) |
| Maximum | drain efficiency loa | d | L. | I | |
| 600 | 4.8 – j1.33 | 11.3 – j5.5 | 172.5 | 70.9 | 20.6 |
| 617 | 4.6 – j0.90 | 8.4 – j3.6 | 217.9 | 69.9 | 20.1 |
| 635 | 4.3 – j0.74 | 6.3 – j2.6 | 249.6 | 66.4 | 19.6 |
| 652 | 3.9 – j0.80 | 6.2 – j2.5 | 202.3 | 59.4 | 19.4 |
| 698 | 3.4 – j1.47 | 6.7 – j0.4 | 194.9 | 71.8 | 21.0 |
| 746 | 3.2 – j2.07 | 5.0 – j0.3 | 214.0 | 72.7 | 20.7 |
| 769 | 3.2 – j2.37 | 5.0 – j0.3 | 206.7 | 72.5 | 20.7 |
| 805 | 3.3 – j2.82 | 3.7 – j0.2 | 198.4 | 72.3 | 20.7 |
| 820 | 3.4 – j3.06 | 3.7 – j0.2 | 197.6 | 72.1 | 20.7 |
| 869 | 4.0 – j3.78 | 3.5 – j0.2 | 175.3 | 71.1 | 20.7 |
| 880 | 4.2 – j3.86 | 3.3 – j1.3 | 211.1 | 70.1 | 20.1 |
| 894 | 4.5 – j3.97 | 3.3 – j1.3 | 197.0 | 69.2 | 20.2 |
| 915 | 4.9 – j4.12 | 3.2 – j1.3 | 184.8 | 69.1 | 20.2 |
| 925 | 5.2 – j4.14 | 3.2 – j1.3 | 176.3 | 69.2 | 20.4 |
| 942 | 5.7 – j4.20 | 2.8 – j2.2 | 200.7 | 68.0 | 19.9 |
| 960 | 6.3 – j4.08 | 2.8 – j2.2 | 186.2 | 67.2 | 20.1 |

[1] Z_S and Z_L defined in Figure 1.

[2] At 3 dB gain compression.

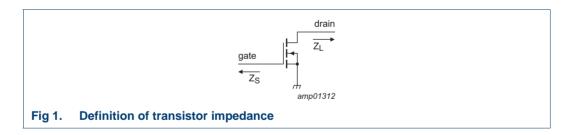


Table 10. Typical impedance of peak device

Measured load-pull data of peak device; $I_{Dq} = 880 \text{ mA}$ (peak); $V_{DS} = 48 \text{ V}$; pulsed CW ($t_p = 100 \mu s$; $\delta = 10 \%$).

| f | Z _S [1] | Z _L [1] | P _L [2] | ղ <mark>ը [2]</mark> | G _p [2] |
|---------|----------------------|--------------------|--------------------|----------------------|--------------------|
| (MHz) | (Ω) | (Ω) | (W) | (%) | (dB) |
| Maximum | power load | I | | I | , I |
| 600 | 3.6 – j1.13 | 2.4 – j3.8 | 453.6 | 59.5 | 17.1 |
| 617 | 3.3 – j1.06 | 2.4 – j3.8 | 438.9 | 57.9 | 17.4 |
| 698 | 2.9 – j1.78 | 1.8 – j3.1 | 445.0 | 58.2 | 17.2 |
| 746 | 3.0 – j2.21 | 1.8 – j3.1 | 435.8 | 59.4 | 17.5 |
| 769 | 3.2 – j2.38 | 2.4 – j3.8 | 428.1 | 61.6 | 17.8 |
| 800 | 3.4 – j2.56 | 2.4 – j3.8 | 416.7 | 61.9 | 17.9 |
| 805 | 3.4 – j2.61 | 2.4 – j3.8 | 434.3 | 63.3 | 17.9 |
| 820 | 3.6 – j2.64 | 2.4 – j3.8 | 430.1 | 63.5 | 17.8 |
| 869 | 4.3 – j2.57 | 2.4 – j3.8 | 408.4 | 64.4 | 18.0 |
| 880 | 4.4 – j2.47 | 2.4 – j3.8 | 402.0 | 64.4 | 18.1 |
| 894 | 4.6 – j2.28 | 2.3 - j3.8 | 388.3 | 64.0 | 18.3 |
| 915 | 5.0 – j1.89 | 1.5 – j4.3 | 382.7 | 54.3 | 16.9 |
| 942 | 5.0 – j1.31 | 1.9 – j5.1 | 381.3 | 52.5 | 16.5 |
| 960 | 4.9 – j0.83 | 1.9 – j5.2 | 378.2 | 53.7 | 16.8 |
| Maximum | drain efficiency loa | ad | · | | |
| 600 | 3.5 – j1.19 | 4.0 - j3.9 | 399.5 | 69.1 | 18.7 |
| 617 | 3.1 – j1.12 | 5.0 – j2.9 | 346.6 | 68.7 | 19.7 |
| 698 | 2.8 – j1.85 | 3.8 – j2.2 | 336.0 | 70.9 | 19.6 |
| 746 | 2.9 – j2.22 | 2.9 – j1.7 | 326.6 | 70.1 | 19.6 |
| 769 | 3.0 – j2.38 | 2.9 – j1.7 | 306.2 | 69.9 | 19.7 |
| 800 | 3.3 – j2.54 | 2.9 – j1.7 | 278.3 | 68.9 | 20.0 |
| 805 | 3.3 – j2.78 | 2.3 – j0.7 | 263.7 | 73.8 | 20.5 |
| 820 | 3.5 – j2.62 | 2.9 – j1.7 | 299.2 | 72.5 | 20.0 |
| 869 | 4.2 – j2.42 | 2.9 – j1.7 | 257.3 | 70.1 | 20.1 |
| 880 | 4.4 – j2.38 | 2.4 – j2.5 | 312.8 | 69.8 | 19.5 |
| 894 | 4.5 – j2.15 | 2.4 – j2.5 | 293.7 | 68.4 | 19.7 |
| 915 | 4.7 – j1.72 | 2.4 – j2.5 | 270.8 | 68.0 | 19.8 |
| 942 | 4.5 – j1.12 | 2.4 – j2.5 | 238.7 | 66.1 | 19.9 |
| 960 | 4.6 – j0.78 | 2.4 - j3.8 | 318.0 | 64.1 | 18.9 |
| | | | | | |

[1] Z_S and Z_L defined in Figure 1.

[2] At 3 dB gain compression.

7.3 Recommended impedances for Doherty design

Table 11. Typical impedance of main at 1 : 1 load

Measured load-pull data of main device; $I_{Dq} = 750 \text{ mA}$ (main); $V_{DS} = 48 \text{ V}$; pulsed CW ($t_p = 100 \mu s$; $\delta = 10 \%$).

| f | Z _S [1] | Z _L [1] | P _{L(3dB)} | ղ <mark>ը [2]</mark> | G _p [2] |
|-------|--------------------|--------------------|---------------------|----------------------|--------------------|
| (MHz) | (Ω) | (Ω) | (W) | (%) | (dB) |
| 720 | 3.3 – j1.7 | 3.6 – j2.1 | 304 | 35.1 | 22.6 |
| 800 | 3.5 – j3.0 | 3.5 – j2.3 | 303 | 34.9 | 22.5 |
| 820 | 3.7 – j3.4 | 3.4 – j2.3 | 298 | 35.3 | 21.9 |
| 869 | 4.5 – j4.2 | 3.0 – j2.2 | 297 | 39.3 | 22.5 |
| 894 | 5.1 – j4.5 | 3.1 – j2.0 | 295 | 37.4 | 22.2 |

[1] Z_S and Z_L defined in Figure 1.

[2] At P_{L(AV)} = 76 W.

Table 12. Typical impedance of main device at 1 : 2.5 load

Measured load-pull data of main device; $I_{Dq} = 750 \text{ mA}$ (main); $V_{DS} = 48 \text{ V}$; pulsed CW ($t_p = 100 \mu s$; $\delta = 10 \%$).

| f | Z _S ^[1] | Z _L [1] | P _{L(3dB)} | ղ <mark>ը [2]</mark> | G _p [2] |
|-------|-------------------------------|---------------------|---------------------|----------------------|--------------------|
| (MHz) | (Ω) | (Ω) | (W) | (%) | (dB) |
| 720 | 3.2 – j2.0 | 6.6 + j1.4 | 172 | 49.2 | 24.8 |
| 800 | 3.4 – j3.1 | 5.4 + j1.1 | 172 | 50.8 | 24.0 |
| 820 | 3.7 – j3.4 | 4.9 + j1.0 | 174 | 50.5 | 24.0 |
| 869 | 4.5 – j4.3 | 3.7 + j0.4 | 174 | 54.3 | 24.1 |
| 894 | 5.1 – j4.6 | 3.6 + j0.4 | 175 | 52.6 | 24.1 |

[1] Z_S and Z_L defined in Figure 1.

[2] At P_{L(AV)} = 76 W.

Table 13. Typical impedance of peak device at 1 : 1 load

Measured load-pull data of peak device; $I_{Dq} = 1100 \text{ mA}$ (peak); $V_{DS} = 48 \text{ V}$; pulsed CW ($t_p = 100 \mu \text{s}$; $\delta = 10 \%$).

| f | Z _S ^[1] | Z _L [1] | P _{L(3dB)} | η <mark>ρ [2]</mark> | G _p [2] |
|-------|-------------------------------|--------------------|---------------------|----------------------|--------------------|
| (MHz) | (Ω) | (Ω) | (W) | (%) | (dB) |
| 720 | 2.7 – j2.0 | 3.0 – j2.4 | 401 | 34.3 | 22.8 |
| 800 | 3.2 – j2.5 | 2.8 – j2.7 | 400 | 32.0 | 22.1 |
| 820 | 3.4 – j2.6 | 2.5 – j3.0 | 412 | 30.8 | 21.6 |
| 869 | 4.1 – j2.6 | 2.4 – j3.2 | 399 | 30.6 | 21.5 |
| 894 | 4.5 – j2.4 | 2.3 – j3.3 | 387 | 30.9 | 21.3 |

[1] Z_S and Z_L defined in Figure 1.

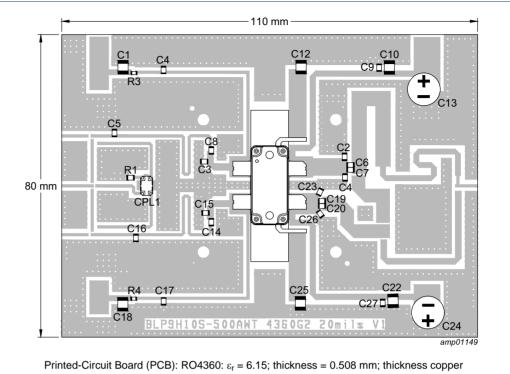
[2] At $P_{L(AV)} = 76$ W.

| | inpedances of peak device |
|-------|---------------------------|
| f | Z _{off} |
| (MHz) | (Ω) |
| 600 | 1.9 + j14.7 |
| 698 | 83.9 – j20.5 |
| 720 | 24.9 – j37.2 |
| 769 | 3.9 – j14.7 |
| 800 | 2.1 – j9.9 |
| 820 | 1.6 – j7.9 |
| 869 | 0.9 – j4.7 |
| 880 | 0.9 – j4.3 |
| 894 | 0.8 – j3.9 |
| 925 | 0.6 – j2.9 |
| 942 | 0.6 – j2.3 |
| 960 | 0.5 – j1.9 |
| | |

Table 14. Off-state impedances of peak device

BLP9H10S-500AWT

7.4 Test circuit



plating = 35 μ m. See <u>Table 15</u> for a list of components.

Fig 2. Component layout

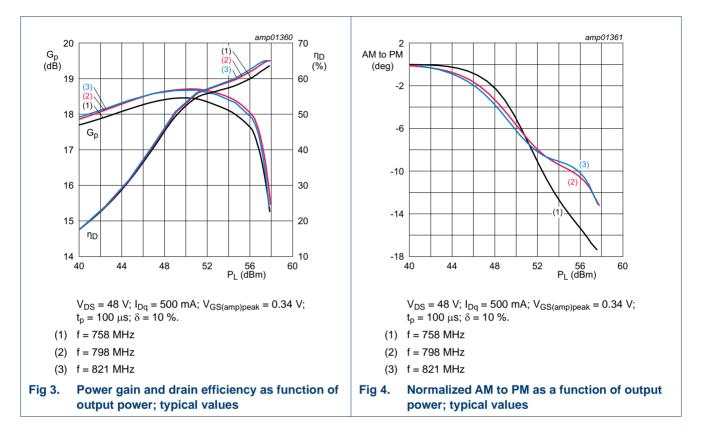
Table 15.List of components

See Figure 2 for component layout.

| Component | Description | Value | Remarks |
|--------------------------------|-----------------------------------|--------------|------------------------------------|
| C1, C10, C12, C18, C22, C25 | multilayer ceramic chip capacitor | 4.7 μF | Murata: SMD 1210 |
| C2, C4 | multilayer ceramic chip capacitor | 5.1 pF | Murata: Hi-Q SMD 0805 |
| C3 | multilayer ceramic chip capacitor | 8 pF | Murata: Hi-Q SMD 0805 |
| C4, C9, C17, C27 | multilayer ceramic chip capacitor | 100 pF | Murata: Hi-Q SMD 0805 |
| C5 | multilayer ceramic chip capacitor | 1.5 pF | Murata: Hi-Q SMD 0805 |
| C6, C7, C19, C20 | multilayer ceramic chip capacitor | 100 pF | Murata: Hi-Q SMD 0805 |
| C8 | multilayer ceramic chip capacitor | 10 pF | Murata: Hi-Q SMD 0805 |
| C13, C24 | electrolytic capacitor | 470 μF, 63 V | |
| C14 | multilayer ceramic chip capacitor | 6.2 pF | Murata: Hi-Q SMD 0805 |
| C15 | multilayer ceramic chip capacitor | 11 pF | Murata: Hi-Q SMD 0805 |
| C16 | multilayer ceramic chip capacitor | 3.3 pF | Murata: Hi-Q SMD 0805 |
| C23, C26 | multilayer ceramic chip capacitor | 8.2 pF | Murata: Hi-Q SMD 0805 |
| R1 | termination | 50 Ω | Anaren: C16A50Z4 |
| R3, R4 | resistor | 5.1 Ω, 1 % | SMD 805 |
| CPL1 | hybrid coupler | 2 dB; 90° | Anaren: Xinger III, X3C07F1-02S |

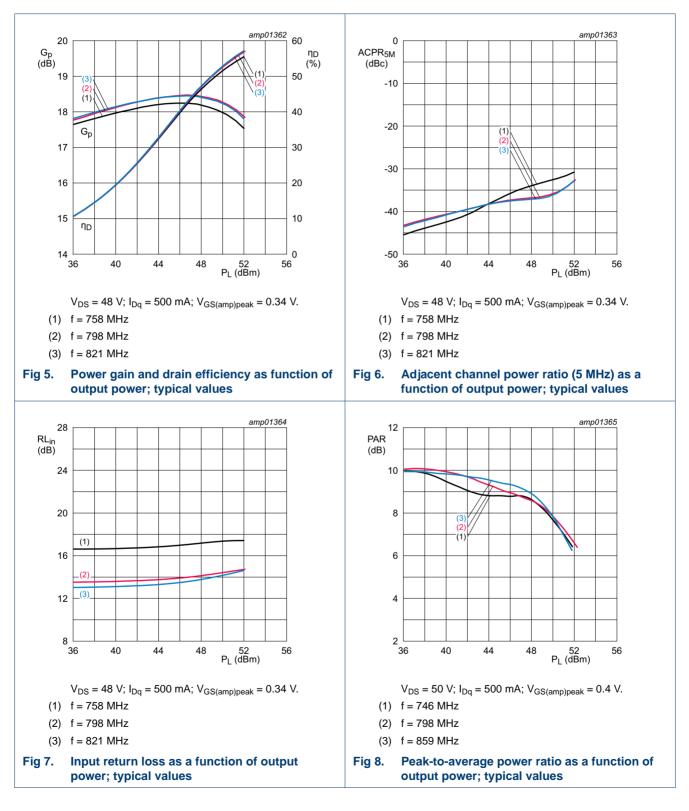
7.5 Graphical data

7.5.1 Pulsed CW



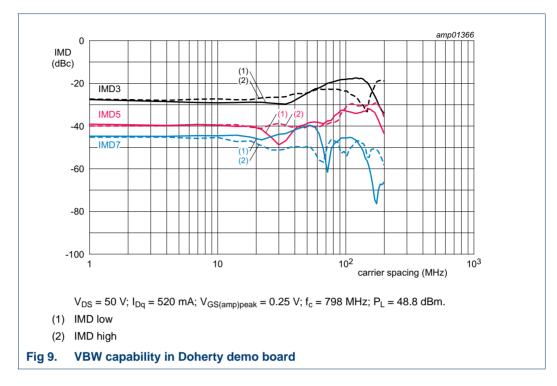
7.5.2 1-Carrier W-CDMA

PAR = 9.9 dB per carrier at 0.01 % probability on CCDF; 3GPP test model 1 with 64 DPCH (100 % clipping).



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7.5.3 2-Tone VBW



BLP9H10S-500AWT

8. Package outline

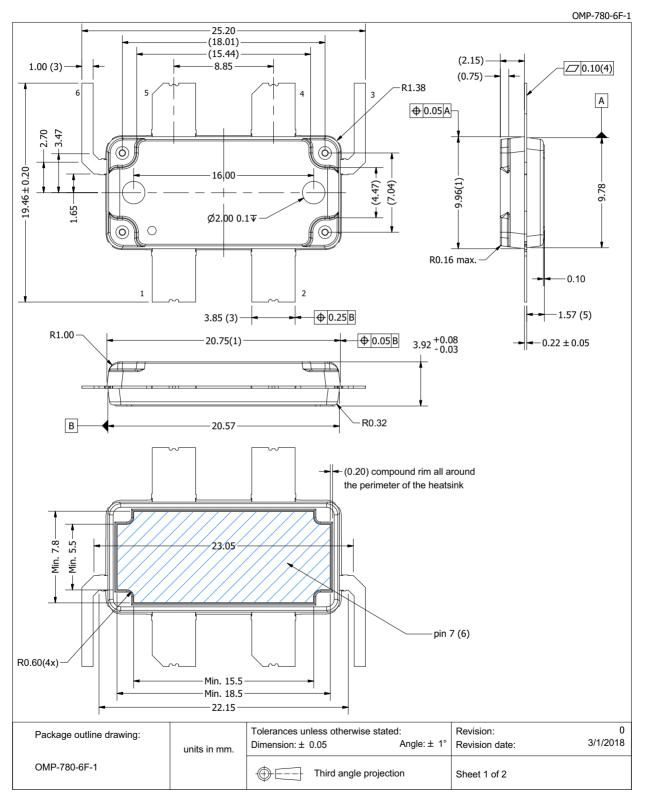


Fig 10. Package outline OMP-780-6F-1 (sheet 1 of 2)

BLP9H10S-500AWT

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BLP9H10S-500AWT

Power LDMOS transistor

OMP-780-6F-1

| Items | | | Description | | |
|------------|---|-----------------------|---|--------|--|
| | Dimensions are exc | cluding mold protru | usion. Areas located adjacent to the leads have a maximum mold protrusion of 0.2 | 25 | |
| (1) | mold protrusion is maximum 0.15 mm per side. See also detail B. | | | | |
| | | | | | |
| (2) | The metal protrusion (tie bars) in the corner will not stick out of the molding compound protrusions (detail A). | | | | |
| (3) | The lead dambar (metal) protrusions are not included. Add 0.14 mm max to the total lead dimension at the dambar location. | | | | |
| (4) | The lead coplanarit | y over all leads is (| 0.1 mm maximum. | | |
| (5) | Dimension is measu | ured 0.5 mm from | the edge of the top package body. | | |
| (6) | The hatched area ir | ndicates the expos | sed metal heatsink. | | |
| (7) | The leads and expo | sed heatsink are | plated with matte Tin (Sn). | | |
| × | | Ó | | | |
| | B | lead dam | A mbar ation DETAIL A SCALE 25:1 A 0,25 mar.(1) 0,25 mar.(1) 0,25 mar.(1) 0,15 | a | |
| Package of | B. | lead dam | A mbar ation DETAIL B | 3/1/20 | |

Fig 11. Package outline OMP-780-6F-1 (sheet 2 of 2)

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9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 16.ESD sensitivity

| ESD model | Class |
|--|--------|
| Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002 | C3 [1] |
| Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001 | 2 [2] |

[1] CDM classification C3 is granted to any part that passes after exposure to an ESD pulse of 1000 V.

[2] HBM classification 2 is granted to any part that passes after exposure to an ESD pulse of 2000 V.

10. Abbreviations

.

| Table 17. Abbr | eviations |
|----------------|--|
| Acronym | Description |
| 3GPP | 3rd Generation Partnership Project |
| AM | Amplitude Modulation |
| CCDF | Complementary Cumulative Distribution Function |
| CW | Continuous Wave |
| DPCH | Dedicated Physical CHannel |
| ESD | ElectroStatic Discharge |
| LDMOS | Laterally Diffused Metal-Oxide Semiconductor |
| ОВО | Output Back Off |
| MTF | Median Time to Failure |
| PAR | Peak-to-Average Ratio |
| PM | Phase Modulation |
| RoHS | Restriction of Hazardous Substances |
| SMD | Surface Mounted Device |
| VBW | Video BandWidth |
| VSWR | Voltage Standing Wave Ratio |
| W-CDMA | Wideband Code Division Multiple Access |

11. Revision history

Table 18. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | |
|---------------------|---|----------------------------|-----------------|---------------------|--|
| BLP9H10S-500AWT v.2 | 20201218 | Product data sheet | - | BLP9H10S-500AWT v.1 | |
| Modifications: | Changed data | a sheet status from object | tive to product | | |
| | • Table 6 on pa | ge 3: updated table | | | |
| | • Table 7 on pa | ige 3: updated table | | | |
| | • Table 8 on pa | ge 4: updated table | | | |
| | Section 7.1 on page 4: changed I_{Dq} from 490 mA to 500 mA | | | | |
| | • Table 14 on p | age 8: updated table | | | |
| BLP9H10S-500AWT v.1 | 20200717 | Objective data sheet | - | - | |

12. Legal information

12.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.ampleon.com.

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Date of release: 18 December 2020 Document identifier: BLP9H10S-500AWT

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